Overview

HP EliteBook 655 15.6 inch G9 Notebook PC



Left

- 1. Internal Microphones (2)
- 2. Webcam LED (Optional)
- 3. Camera Shutter (Only available with webcam)
- 4. HD TNR and IR Camera (Optional)
- 5. IR Camera LED (Optional)

- 6. Clickpad
- 7. Smartcard Reader (Optional)
- 8. SuperSpeed USB Type-A 5Gbps signaling rate port
- 9. Ethernet Port (RJ-45)
- 10. Nano Security Lock Slot (Lock sold separately)



Overview



Right

- 1. Power Button Key
- 2. Power Connector
- SuperSpeed USB Type-C[®] 10Gbps signaling rate (USB Power Delivery, DisplayPort[™] 1.4)
- 4. SuperSpeed USB Type-A 5Gbps signaling rate port
- 5. SuperSpeed USB Type-A 5Gbps signaling rate port
- 6. HDMI 2.0b Port (Cable not included)
- 7. Audio Combo Jack
- 8. External SIM Card Slot (Optional)
- 9. Touch Fingerprint Sensor (Select Models)



Overview

AT A GLANCE

- Preinstalled with Windows 11 Pro, other Windows OS or FreeDOS
- Fast and upgradeable dual channel DDR4 SODIMM memory up to 64 GB
- Choice of AMD Barcelo™ 5000 series mobile processors, R7, R5 and R3
- Choice of 35.56 cm (14") diagonal HD, Ultra Wide Viewing Angle FHD, Touch or Non-Touch screen, and Privacy Panel option.
- Features redesigned quiet and responsive HP Keyboard with the HP Programmable key and backlit options
- Choice of solid state drives up to 1 TB
- Multi-layered security with HP SureStart Gen7, HP Privacy Camera, HP Sure View Gen4, HP Wolf Security (Includes HP Sure Sense and HP Sure Click), HP Secure Erase, HP Client Security Manager Gen7 (Includes Sure Run Gen5, Sure Recover Gen5), Touch Fingerprint reader, and Tamper Lock
- Supports wireless options for connectivity on the go including gigabit-speed Wi-Fi® 6e and CAT9 4G/LTE WWAN
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles
- Designed to support HP docking options
- Passed 19 MIL-STD 810H tests
- Battery Life up to 19 hours with the optional 51.3Whr battery
- Optimize your video calls with an HD camera and temporal noise reduction that adjusts to the lighting in your environment.
- 180° synchronized hinge allows the EliteBook to lay completely flat, without lifting the keyboard, and includes everyone
 with visibility from multiple angles.

NOTE: See important legal disclosures for all listed specs in their respective features sections.

PRODUCT NAME

HP EliteBook 655 15.6 inch G9 Notebook PC

OPERATING SYSTEM

Preinstalled Windows 11 Pro¹

Windows 11 Pro Education ¹ Windows 11 Home - HP recommends Windows 11 Pro for business ¹ Windows 11 Home Single Language - HP recommends Windows 11 Pro for business ¹ Windows 11 Pro (Windows 11 Enterprise available with a Volume Licensing Agreement) ¹ Windows 10 Pro (available through downgrade rights from Windows 11 Pro) ^{1,2} FreeDOS

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

2. This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

PROCESSORS

AMD Ryzen[™] 7 PRO 5875U (2.00 GHz base clock, up to 4.50 GHz max boost clock, 16 MB L3 cache, 8 cores, 16 threads) ^{3,4,5,6} AMD Ryzen[™] 7 5825U (2.00 GHz base clock, 16 MB L3 cache, 8 cores, 16 threads) ^{3,4,5,6} AMD Ryzen[™] 5 PRO 5675U (2.30 GHz base clock, up to 4.30 GHz max boost clock, 16 MB L3 cache, 6 cores, 12 threads) ^{3,4,5,6} AMD Ryzen[™] 5 5625U (2.30 GHz base clock, 16 MB L3 cache, 6 cores, 12 threads) ^{3,4,5,6} AMD Ryzen[™] 3 5425U (2.70 GHz base clock, 8 MB L3 cache, 4 cores, 8 threads) ^{3,4,5,6}

Processor Family

AMD Ryzen[™] processor ⁶

3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD 's numbering is not a measurement of clock speed.

4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.

5. AMD Max Boost frequency performance varies depending on hardware, software and overall system configuration.

6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.



CHIPSET

Chipset is integrated with processor.

GRAPHICS

Integrated AMD Radeon Graphics

Supports Support HD decode, DX12, HDMI 2.1b⁷

7. HD content required to view HD images.

DISPLAY

Non-Touch

39.6 cm (15.6") diagonal FHD (1920x1080) UWVA eDP, anti-glare, LED, low power, narrow bezel bent, 400 nits, 100% for HD + IR camera for WWAN ^{7,8}

39.6 cm (15.6") diagonal FHD (1920x1080) UWVA eDP, anti-glare, WLED, low power, narrow bezel bent, 400 nits, 100% for HD camera ^{7,8}

39.6 cm (15.6") diagonal FHD (1920x1080) UWVA eDP, anti-glare, LED, narrow bezel bent, 250 nits, 45% for HD + IR camera for WWAN ^{7,8}

39.6 cm (15.6") diagonal FHD (1920x1080) UWVA eDP, anti-glare, WLED, narrow bezel bent, 250 nits, 45% for HD camera for WWAN ^{7,8}

39.6 cm (15.6") diagonal FHD (1920x1080) UWVA eDP, anti-glare, LED, narrow bezel bent, 250 nits, 45% for HD + IR camera ^{7,8} 39.6 cm (15.6") diagonal FHD (1920x1080) UWVA eDP, anti-glare, WLED, narrow bezel bent, 250 nits, 45% for HD camera ^{7,8} 39.6 cm (15.6") diagonal FHD (1920x1080) UWVA eDP 1.2 w/o PSR, anti-glare, WLED, narrow bezel bent, 250 nits, 45% for HD camera ^{7,8} 39.6 cm (15.6") diagonal HD (1920x1080) SVA, eDP, anti-glare, WLED, narrow bezel bent, 250 nits, 45% for HD camera ^{7,8} 39.6 cm (15.6") diagonal HD (1920x1080) SVA, eDP, anti-glare, WLED, narrow bezel bent, 250 nits, 45% for HD camera ^{7,8} 39.6 cm (15.6") diagonal HD (1920x1080) SVA, eDP 1.2 w/o PSR, anti-glare, WLED, narrow bezel bent, 250 nits, 45% for HD camera ^{7,8}

Touch

39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare narrow bezel bent touch-on-panel screen, 250 nits, 45% NTSC for HD + IR camera and WWAN (1920 x 1080) ^{7,8,9,10}

39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare narrow bezel bent touch-on-panel screen, 250 nits, 45% NTSC for HD camera (1920 x 1080) ^{7,8,9,10}

Display Size

15.6" diagonal 39.6 cm (15.6") diagonal

7. HD content required to view HD images.

8. Resolutions are dependent upon monitor capability, and resolution and color depth settings.

- 9. Sold separately or as an optional feature.
- 10. Actual brightness will be lower with touchscreen or HP Sure View.



DOCKING (Sold Separately)

Docking station model #1 Docking station model #2 Docking station model #3

HP Thunderbolt Dock G2 HP USB-C Dock G5 HP USB-C/A Universal Dock G2

For additional aftermarket options and docking specs please see page 40.

STORAGE AND DRIVES

Primary M.2 Storage

128 GB PCIe[®] NVMe[™] M.2 Value Solid State Drive ¹¹
256 GB PCIe[®] NVMe[™] M.2 Value Solid State Drive ¹¹
256 GB PCIe[®] Gen4x4 NVMe[™] M.2 TLC Self Encrypted OPAL2 Solid State Drive ^{11,12}
256 GB PCIe[®] Gen4x4 NVMe[™] M.2 TLC single-sided Solid State Drive ^{11,12}
256 GB PCIe[®] Gen4x4 NVMe[™] M.2 SSD ¹¹
512 GB PCIe[®] Gen4x4 NVMe[™] M.2 TLC Self Encrypted OPAL2 Solid State Drive ^{11,12}
512 GB PCIe[®] Gen4x4 NVMe[™] M.2 TLC Solid State Drive ^{11,12}
512 GB PCIe[®] Gen4x4 NVMe[™] M.2 TLC Solid State Drive ^{11,12}
512 GB PCIe[®] Gen4x4 NVMe[™] M.2 TLC Solid State Drive ^{11,12}
512 GB PCIe[®] Gen4x4 NVMe[™] M.2 TLC Solid State Drive ^{11,12}

Secondary M.2 Storage (Optional)

128 GB PCIe[®] NVMe[™] M.2 Value Solid State Drive ^{11,13} 256 GB PCIe[®] NVMe[™] M.2 Value Solid State Drive ^{11,13}

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows
 is reserved for system recovery software.

12. Only functions at the Gen3x4 capacity with AMD Ryzen Barcelo processor.

13. Second storage is only available with non-WWAN base Unit AND Primary M.2 storage

MEMORY

Maximum Memory 64 GB DDR4-3200 SDRAM¹⁴

Memory

64 GB DDR4-3200 SDRAM (2 x 32 GB) ¹⁴ 32 GB DDR4-3200 SDRAM (1 x 32 GB) ¹⁴ 32 GB DDR4-3200 SDRAM (2 x 16 GB) ¹⁴ 16 GB DDR4-3200 SDRAM (1 x 16 GB) ¹⁴ 16 GB DDR4-3200 SDRAM (2 x 8 GB) ¹⁴ 8 GB DDR4-3200 SDRAM (1 x 8 GB) ¹⁴ 8 GB DDR4-3200 SDRAM (2 x 4 GB) ¹⁴

Memory Slots

2 SODIMM Both slots are customer accessible / upgradeable DDR4 PC4 SODIMMS (Barcelo runs at 3200) Supports Dual Channel Memory



14. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

WLAN

Realtek RTL8852BE 802.11ax 2x2 Wi-Fi[®] + BT5.2 ¹⁵ Qualcomm[®] Fast Connect 6900 Wi-Fi 6E + BT5.2 (802.11ax 2x2) ¹⁶

WWAN

Intel[®] XMM[™] 7560 R+ LTE-Advanced Pro Cat 16¹⁷

NFC

NXP NPC300 Near Field Communication Module (NFC Mirage WNC XRAV-1)

Ethernet

Realtek RTL8111HSH 10/100/1000 Integrated NIC ¹⁸ Realtek RTL8111FPH 10/100/1000 Integrated NIC ¹⁸

Wake on WLAN

Support on S3 AC mode only

15. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs.

16. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

17. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

18. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.



AUDIO/MULTIMEDIA

Audio

2 Integrated stereo speakers Integrated microphone (Dual Array)

Speaker Power

2W/4ohm Per speaker

Camera

720p HD camera with Temporal Noise Reduction ^{7,9}
 720p HD camera+IR Camera with Temporal Noise Reduction ^{7,9}

7. HD content required to view HD images.

9. Sold separately or as an optional feature.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Premium Keyboard, spill resistant with optional backlit function ¹⁹

Pointing Device

Clickpad with multi-touch gesture support

Function Keys

- F1 Display Switching
- F2 Blank
- F3 Brightness Down
- F4 Brightness Up
- F5 Audio Mute
- F6 Volume Down
- F7 Volume Up
- F8 Mic Mute
- F9 Blank or Backlit Toggle
- F10 Insert
- F11 Wireless
- F12 Programmable key

Hidden Function Keys

Fn+R - Break

Fn+S - Sys Rq Fn+C - Scroll Lock

19. Backlit keyboard is an optional feature.



SOFTWARE AND SECURITY

Software

HP Quick Touch HP Quick Drop ²⁰ HP PC Hardware Diagnostics Windows Touchpoint Customizer for Commercial myHP HP Smart Support ²¹ HP Connection Optimizer HP Hotkey Support HP Support Assistant ²² HP Notifications HP Privacy Settings Buy Microsoft Office (Sold separately)

Manageability Features

HP Connect for Microsoft Endpoint Manager²³ HP Image Assistant Gen5 (download) HP Manageability Integration Kit (download)²⁴ HP Client Management Script Library (download) HP Patch Assistant (download)²⁵ HP Driver Packs (download) HP Client Catalog (download)

Security Management

HP Wolf Security of Business²⁶ includes:

HP Sure Click ²⁷ HP Sure Sense 2 ²⁸ HP Sure Run Gen5 ²⁹ HP Sure Recover Gen5 ³⁰ HP Sure Start Gen7 ³¹ HP Tamper Loc HP Sure Admin ³² HP Client Security Manager Gen7 ³³

BIOS

HP BIOSphere Gen6 ³⁴ HP Secure Erase ³⁵ Absolute Persistence Module ³⁶ HP DriveLock & Automatic DriveLock BIOS Update via Network HP Wake on WLAN HP Fingerprint Sensor ³⁷ Secured-Core PC Enable ³⁸ TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified)

Security

TPM Model: Infineon SLB9672VU2.0 Version:15.21



Revision: TPM 2.0 FIPS 140-2 Compliant: Yes

Smartcard Reader

Model number: Alcor AU9560 FIPS 201 Compliant: Yes

IPv6 Compliance Yes

FirstNet Certified No

Is the BIOS on this notebook ISO/IEC 19678:2015 (formerly NIST 800-147) compliant?: Yes UEFI version: 2.7 Class: Class 3

20. HP Quick Drop requires Internet access and Windows 10 or higher PC preinstalled with HP QuickDrop app and either an Android device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.

21. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or it can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.

22. HP Support Assistant requires Windows and Internet Access

23. HP Connect for Microsoft Endpoint Manager is available from the Azure Market Place for HP Pro, Elite, Z and Point-of-Sale PCs managed with Microsoft Endpoint Manager. Subscription to Microsoft Endpoint Manager required and sold separately. Network connection required.

24. HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement.

25. HP Patch Assistant available on select HP PCs with the HP Manageability Kit that are managed through Microsoft System Center Configuration Manager. HP Manageability Integration Kit can be downloaded from

http://www8.hp.com/us/en/ads/clientmanagement/overview.html.

26. HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features and OS requirement.

27. HP Sure Click requires Windows 10 Pro or higher or Enterprise. See https://bit.ly/2PrLT6A_SureClick for complete details.
28. HP Sure Sense is available on select HP PCs with Windows 10 Pro, Windows 10 Enterprise, Windows 11 Pro, or Windows 11 Enterprise OS.

29. HP Sure Run Gen5 is available on select HP PCs and requires Windows 10 and higher.

30. HP Sure Recover Gen5 is available on select HP PCs and requires Windows 10 and higher and an open network

connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module.

31. HP Sure Start Gen7 is available on select HP PCs and requires Windows 10 and higher.

32. HP Sure Admin requires Windows 10 and higher, HP BIOS, HP Manageability Integration Kit from

http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.

33. HP Client Security Manager Gen7 requires Windows and is available on the select HP Elite and Pro PCs.

34. HP BIOSphere Gen6 features may vary depending on the platform and configuration.

35. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel[®] Optane[™].



36. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: https://www.absolute.com/about/legal/agreements/absolute/.

37. Fingerprint Reader is an optional feature that must be configured at purchase.

38. Requires an Intel[®] vPro[®], AMD Ryzen[™] Pro processor or Qualcomm[®] processor with SD850 or higher and requires 8 GB or more system memory. Secured-core PC is enabled from the factory.

POWER

Power Supply

AC Adapter 45 Watt nPFC Standard USB type C Straight 1.8m ³⁹ AC Adapter 45 Watt Smart nPFC Standard Barrel 4.5mm Right Angle 1.8m ³⁹ AC Adapter 45 Watt Smart nPFC Standard C8 for 2 prong Barrel 4.5mm Right Angle ³⁹ AC Adapter 65 Watt nPFC Standard USB type C Straight 1.8m ³⁹ AC Adapter 65 Watt Smart nPFC EM Barrel 4.5mm ³⁹ AC Adapter 65 Watt Smart nPFC Standard Barrel 4.5mm Right Angle 1.8m ³⁹

Battery

HP Long Life 3-cell, 42.75 Wh Polymer ^{40,41} HP Long Life 3-cell, 51.3 Wh Polymer ^{40,41}

Power Cord

3-wire plug - 1m 2-wire plug - 1m

Battery Life

Up to 19 hours with 51whr battery (HP Long Life 3-Cell, 51 Whr Polymer, UMA graphic, AMD R7, 200 nits display, 8G memory, 256 GB SSD) ⁴²

Up to 16 hours with 42whr battery (HP Long Life 3-Cell, 42 Whr Polymer, UMA graphic, AMD R7, 200 nits display, 8G memory, 256 GB SSD)⁴²

Battery Weight

HP Long Life 3-cell - 42.75 Wh Polymer - .40 lb HP Long Life 3-cell - 51.3 Wh Polymer - .45 lb HP Long Life 3-cell - 42.75 Wh Polymer - 181.83 g HP Long Life 3-cell - 51.3 Wh Polymer - 203.56 g

39. Availability may vary by country.

40. Battery is internal and not replaceable by customer. Serviceable by warranty.

41. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

42. Windows 10 MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See http://www.bapco.com for additional details..



WEIGHTS & DIMENSIONS

Product Weight Starting at 3.83 lb ⁴³ Starting at 1.74 kg ⁴³

Product Dimensions (W x D x H)

14.15 x 9.20 x 0.78 in 35.94 x 23.39 x 1.99 cm

43. Weight will vary by configuration. Does not include power adapter.

PORTS/SLOTS

Ports

SuperSpeed USB Type-C[®] 10Gbps signaling rate (USB Power Delivery, DisplayPort[™] 1.4)
 SuperSpeed USB Type-A 5Gbps signaling rate Port (1 Powered port)1 SuperSpeed USB Type-A 5Gbps signaling rate Port (Power delivery)1 AC power
 HDMI 2.0b⁴⁴
 Headphone/microphone combo jack
 Nano SIM slot for WWAN (optional)

Expansion Slots Smart Card Reader (optional)

44. HDMI cable sold separately.



SERVICE AND SUPPORT

HP Services offers 1-year or 3-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc⁴⁵

45. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

CERTIFICATION AND COMPLIANCE

Energy Efficiency Compliance: ENERGY STAR® certified Energy Efficiency Compliance: EPEAT® 2019 Gold ⁴⁶ Environmental Specifications: Low halogen ⁴⁷ Environmental Specifications: TCO 9.0 Certification

46. Based on US EPEAT[®] registration according to IEEE 1680.1-2018 EPEAT[®]. EPEAT[®] status varies by country. Visit http://www.epeat.net for more information

47. External power supplies, power cords, cables and peripherals are not Low Halogen. Service parts obtained after purchase may not be Low Halogen.



SYSTEM UNIT

19V 7.52W (Idle)
Yes (AMD Radeon™ Graphics)
N/A
Discrete < 65W UMA < 45W
32° to 95° F (0° to 35° C)
-4° to 140° F (-20° to 60° C)
10% to 90%, non-condensing
5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature
40 G, 2 ms, half-sine
200 G, 2 ms, half-sine
1.043 grams
3.5 grams
-50 to 10,000 ft (-15.24 to 3,048 m)
-50 to 40,000 ft (-15.24 to 12,192 m)
HSN-Q35C-5
Yes
Yes
Yes
Yes ⁴⁸
EPEAT [®] 2019 Gold in the United States ⁴⁹
Yes
Yes Yes



48. Configurations of the HP EliteBook 655 G9 that are ENERGY STAR[®] qualified are identified as HP EliteBook 655 G9 ENERGY STAR[®] on HP websites and on http://www.energystar.gov.
49. Based on US EPEAT[®] registration according to IEEE 1680.1-2018 EPEAT[®]. EPEAT[®] status varies by country. Visit

http://www.epeat.net for more information.

DISPLAYS

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

1. Actual brightness will be lower with touchscreen or HP Sure View.

Panel LCD 15.6 inch FHD (1920 x 1080) Anti-Glare WLED UWVA 45percent cg 250nits eDP 1.2 w/o PSR bent Touch on Panel NWBZ	Outline Dimensions (W x H) Active Area Weight Diagonal Size Thickness Interface Surface Treatment Touch Enabled Contrast Ratio Refresh Rate Brightness Pixel Resolution Format Backlight Color Gamut Coverage Color Depth Viewing Angle Low Blue Light Power Consumption (W, EBL@ 150nits max/ 200nits max)	350.960 x 205.740 (max) 344.160 x 193.590 mm (typ) 380 g(max) 15.6 inch 3.2 / 5.2 (max) eDP 1.2 Anti-Glare On-cell Yes ¹ 600:1 (typ) 60 (typ) 250 nits ¹ 1920 x 1080 (FHD) WLED RGB NTSC 45% 6 UWVA 85/85/85/85 No 2.54 (Max) / 3.12 (Max)
15.6 inch FHD (1920 x 1080) Anti-Glare WLED UWVA sRGB 100percent cg 400nits eDP 1.4+PSR2 bent LP NWBZ	Outline Dimensions (W x H) Active Area Weight Diagonal Size Thickness Interface Surface Treatment Touch Enabled Contrast Ratio Refresh Rate Brightness	349.460 x 204.790 (max) 344.160 x 193.590 mm (typ) 325 g (max) 15.6 inch 2.6 / 4.6 (max) eDP 1.4 Anti-Glare No 1200:1 (typ) 60 (typ) 400 (typ)

Pixel Resolution

Format

Backlight



1920 x 1080 (FHD)

WLED

RGB

Technical Specifications

•		
	Color Gamut Coverage	sRGB 100%
	Color Depth	8
	Viewing Angle	UWVA 85/85/85/85
	Low Blue Light	No
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	1.13 (Max) / 1.37 (Max)
15.6 inch FHD (1920 x 1080) Anti-	Outline Dimensions (W x H)	350.960 x 205.540 (max)
Glare WLED UWVA 45percent cg 250nits eDP 1.2 w/o PSR bent	Active Area	344.160 x 193.590 mm (typ)
NWBZ	Weight	370 g (max)
	Diagonal Size	15.6 inch
	Thickness	3.0 / 5.0 (max)
	Interface	eDP 1.2
	Surface Treatment	Anti-Glare
	Touch Enabled	No
	Contrast Ratio	600:1 (typ)
	Refresh Rate	60 (typ)
	Brightness	250 (typ)
	Pixel Resolution	1920 x 1080 (FHD)
	Format	WLED
	Backlight	RGB
	-	NTSC 45%
	Color Gamut Coverage	6 (Hi FRC w/ condition to enable)
	Color Depth	UWVA 85/85/85/85
	Viewing Angle Low Blue Light	No
	Power Consumption (W, EBL@	2.62 (Max) / 3.27 (Max)
	150nits max/ 200nits max)	2.02 (Mdx) / 5.27 (Mdx)
15 6 in UD (1266 y 760)		
15.6-in HD (1366 x 768) Anti-Glare WLED SVA 45percent	Outline Dimensions (W x H x D)	350.960 x 205.540 (max)
cg 250nits eDP 1.2 w/o PSR	Active Area	344.230 x 193.540 mm (typ)
NWBZ bent	Weight	370 g (max)
	Diagonal Size	15.6 inch
	Thickness	3.2 / 5.0 (max)
	Interface	eDP 1.2
	Surface Treatment	Anti-Glare
	Touch Enabled	No
	Contrast Ratio	300:1 (typ)
	Refresh Rate	60 (typ)
	Brightness	250 (typ)
	Pixel Resolution	1366 x 768 (HD)
	Format	WLED
	Backlight	RGB
	Color Gamut Coverage	NTSC 45%
	Color Depth	6



Viewing Angle Low Blue Light Power Consumption (W, EBL@ 150nits max/ 200nits max) SVA 45/45/15/35 No 2.49 (Max) / 2.78 (Max)



STORAGE AND DRIVES

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

SSD 128GB 2230 PCIe	Drive Weight	M.2 2230
NVMe Value	Rotation speed	128GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.01 lb (5 g)
	Interface	PCIe NVMe Gen3
	Maximum Sequential Read	Up to 2100 MB/s
	Maximum Sequential Write	Up to 1200 MB/s
	Logical Blocks	250069680
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	Pyrite; TRIM; L1.2
SSD 256GB 2230 PCIe	Form Factor	M.2 2230
NVMe Value	Capacity	256 GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen3
	Maximum Sequential Read	up to 2500 MB/s
	Maximum Sequential Write	up to 1300 MB/s
	Logical Blocks	500118192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	Pyrite; TRIM; L1.2
SSD 256GB 2280 PCle	Form Factor	M.2 2280
NVMe Value	Capacity	256GB
	NAND Type	Value
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen3
	Maximum Sequential Read	Up to 2900 MB/s
	Maximum Sequential Write	Up to 1400 MB/s
	Logical Blocks	500118192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security; TRIM; L1.2



		M 2 2200
SSD 256GB 2280 PCIe-4x4 NVMe Three Layer Cell	Form Factor	M.2 2280
NVME THEE Layer Cell	Capacity	256 GB
	NAND Type	3D TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	9.0g
	Interface	PCIe NVMe Gen4
	Maximum Sequential Read	Up to 6,400 MB/s
	Maximum Sequential Write Logical Blocks	Up to 2,700 MB/s 500118192
	-	
	Operating Temperature Features	32° to 158°F (0° to 70°C) [ambient temp] Pyrite 2.0; TRIM; L1.2
256GB PCIe-4x4 2280 NVME	Form Factor	M.2 2280
Self Encrypted OPAL2 Three	Capacity	256GB
Layer Cell Solid State Drive	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen4
	Maximum Sequential Read	6400
	Maximum Sequential Write	2700
	Logical Blocks	500118192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security (Option); TCG Opal 2.0; TRIM; L1.2
SSD 512GB 2280 PCIe NVMe	Form Factor	M.2 2280
Value	Capacity	512GB
	NAND Type	Value
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen3
	Maximum Sequential Read	Up to 3500 MB/s
	-	
	Maximum Sequential Write	up to 3000 MB/s
	•	up to 3000 MB/s 1000215216
	Maximum Sequential Write Logical Blocks Operating Temperature	-

SSD 512GB 2280 PCIe-4x4 NVMe Three Layer Cell	Form Factor	M.2 2280
	Capacity	512GB
	NAND Type	3D TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	9.0g
	Interface	PCIe NVMe Gen4
	Maximum Sequential Read	Up to 6,600 MB/s
	Maximum Sequential Write	Up to 5,100 MB/s
	Logical Blocks	1000215216
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	Pyrite 2.0; TRIM; L1.2
512GB PCIe-4x4 2280 NVME	Form Factor	M.2 2280
Self Encrypted OPAL2 Three	Capacity	512GB
Layer Cell Solid State Drive	NAND Type	TLC
-	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen4
	Maximum Sequential Read	Up to 6,600 MB/s
	Maximum Sequential Write	Up to 5,100 MB/s
	Logical Blocks	1000215216
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security (Option); TCG Opal 2.0; TRIM; L1.2
		N 2 2200
SSD 1TB 2280 PCIe-4x4 NVMe Three Layer Cell	Form Factor	M.2 2280
NVME THEE Layer Cell	Capacity	1TB
	NAND Type	3D TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface Maximum Convention Dead	PCIe NVMe Gen4
	Maximum Sequential Read	Up to 7,100 MB/s
	Maximum Sequential Write	Up to 5,200 MB/s 2000409264
	Logical Blocks Operating Temperature	2000409264 32° to 158°F (0° to 70°C) [ambient temp]
	Features	Pyrite 2.0; TRIM; L1.2
		r yrite 2.0, TRIM, ET.2



NETWORKING/COMMUNICATIONS

Qualcomm [®] Fast Connect 6900 Wi-Fi 6E + BT5.2 (802.11ax 2x2, AMD AIM-T AME, supporting gigabit file transfer speeds) ¹		IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11h IEEE 802.11h IEEE 802.11k IEEE 802.11r IEEE 802.11v IEEE 802.11v IEEE 802.11w
	Interoperability Frequency Band	Wi-Fi certified •802.11b/g/n/ax 2.402 – 2.482 GHz •802.11a/n/ac/ax 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz 5.925 – 7.125 GHz
	Data Rates	 •802.11b: 1, 2, 5.5, 11 Mbps •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: MCS 0 ~ MCS 15, (20MHz, and 40MHz) •802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, ,80MHz & 160MHz) • 802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, ,80MHz & 160MHz)
	Modulation Security ³	Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM, 4096QAM •AES-CCMP: 128 bit in hardware •802.1x authentication •WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. •WPA2 certification •IEEE 802.11i
	Network Architecture Models Roaming Output Power ²	Wi-Fi Direct in Win10 for peer-to-peer connection. Infrastructure (Access Point Required) IEEE 802.11 compliant roaming between access points 2.4GHz (MIMO, typical): • 802.11b: +18dBm • 802.11g: +16.5dBm • 802.11n/ac/ax (HT20/VHT20/HE20): +16dBm • 802.11n/ac/ax (HT40/VHT40/HE40): +12.5dBm 5GHz (MIMO, typical): • 802.11a: +13dBm • 802.11n/ac/ax (HT20/VHT20/HE20): +13.5dBm • 802.11n/ac/ax (HT40/VHT40/HE40): +12.5dBm • 802.11n/ac/ax (HT40/VHT40/HE40): +12.5dBm



Technical Specifications 802.11ax HE160: +11.5dBm 6GHz LPI mode (MIMO, typical): 802.11a: 0dBm • 802.11ax HE20: +1dBm • 802.11ax HE40: +4dBm 802.11ax HE80: +7dBm • 802.11ax HE160: +7.5dBm **Power Consumption** Transmit mode: 3.0 W Receive mode: 2.0 W Idle mode (WLAN associated): 300mW Idle mode (WLAN unassociated): 100mW Modern Connected Standby: 10mW Radio disabled: 8 mW **Power Management** ACPI and PCI Express compliant power management 802.11 compliant power saving mode **Receiver Sensitivity⁴** 2.4GHz (SISO): • 802.11b, 11Mbps: -82dBm maximum 802.11g, 54Mbps: -71dBm maximum • 802.11n, MCS7: -64dBm maximum 802.11ac, MCS9: -52dBm maximum • 802.11ax, MCS11(HT40): -49dBm maximum 5GHz (SISO): • 802.11a, 54Mbps: -71dBm maximum • 802.11n, MCS07: -64dBm maximum 802.11ac, MCS9: -52dBm maximum 802.11ax, MCS11(HE80/HE160): -46dBm maximum 6GHz (SISO): 802.11a, 54Mbps: -71dBm maximum • 802.11n, MCS7: -64dBm maximum • 802.11ac. MCS9: -52dBm maximum 802.11ax, MCS11(HE160): -46dBm maximum" High efficiency antenna with spatial diversity, mounted in the display Antenna type enclosure. Two embedded dual band 2.4/5/6 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications Form Factor PCI-Express M.2 MiniCard Dimensions Type 2230: 2.3 x 22.0 x 30.0 mm Weight Type 2230: 3g **Operating Voltage** 3.3 +/ 0.165v Temperature Operating -10° to 60° C Non-operating -40° to 85° C Humidity Operating 10% to 60% (non-condensing) Non-operating 5% to 95% (non-condensing)" Altitude 0 to 10,000 ft (3,048 m) Operating Non-operating 0 to 50,000 ft (15,240 m) **LED Activity** N/A HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2 Wireless Technology **Bluetooth Specification** 4.0/4.1/4.2/5.0/5.1/5.2 Compliant **Frequency Band** 2402 to 2480 MHz Number of Available Legacy: 0~79 (1 MHz/CH) Channels BLE: 0~39 (2 MHz/CH) **Data Rates and** Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps



Throughput	BLE: 1 Mbps data rate; throughput up to 0.2 Mbps Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class 1.5 Bluetooth device with a maximum transmit power of + 14 dBm and 10 dBm for BR and EDR, respectively.

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

3. Check latest software/driver release for updates on supported security features.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Realtek RTL8852BE 802.11ax 2x2 Wi-Fi® + BT5.2 (802.11ax 2x2, supporting gigabit data rate) ¹	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v
	Interoperability	Wi-Fi certified modules
	Frequency Band	•802.11b/g/n/ax 2.402 – 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz
	Data Rates	•802.11b: 1, 2, 5.5, 11 Mbps •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: max 300Mbps •802.11ac: max 866.7Mbps • 802.11ax: max 1201Mbps
	Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM
	Security ³	 IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication



	•WPA, WPA2: 80 •WPA2 certificat •WPA3 certificat •IEEE 802.11i •WAPI		
Network Architecture Models	Ad-hoc (Peer to I Infrastructure (A	Peer) ccess Point Required)	
Roaming Output Power ²	IEEE 802.11 compliant roaming between access points • 802.11b: +18.5dBm minimum • 802.11g: +17.5dBm minimum • 802.11a: +18.5dBm minimum • 802.11n HT20(2.4GHz): +15.5dBm minimum • 802.11n HT40(2.4GHz): +14.5dBm minimum • 802.11n HT20(5GHz): +15.5dBm minimum • 802.11n HT40(5GHz): +14.5dBm minimum • 802.11ac VHT80(5GHz): +11.5dBm minimum • 802.11ax HE40(2.4GHz): +10dBm minimum • 802.11ax HE80(5GHz): +10dBm minimum		
Power Consumption	•Transmit mode:2.5 W •Receive mode:2 W •Idle mode (PSP)180 mW(WLAN Associated) •Idle mode:50 mW(WLAN unassociated) •Connected Standby/Modern Standby: 10mW •Radio disabled: 8 mW		
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode		
Receiver Sensitivity ⁴	 •802.11b, 1Mbps : -93.5dBm maximum •802.11b, 11Mbps : -84dBm maximum •802.11a/g, 6Mbps : -86dBm maximum •802.11a/g, 54Mbps : -72dBm maximum •802.11n, MCS07 : -67dBm maximum •802.11n, MCS15 : -64dBm maximum •802.11ac, MCS0 : -84dBm maximum •802.11ac, MCS9 : -59dBm maximum •802.11ax, MCS11(HE40): -57dBm maximum •802.11ax, MCS11(HE80): -54dBm maximum 		
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications		
Form Factor	PCI-Express M.2 MiniCard		
Dimensions	1. Type 2230: 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm		
Weight	1. Type 2230: 2.8g 2. Type 126: 1.3g		
Operating Voltage	3.3v +/- 9%		
Temperature	Operating Non-operating	14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C)	
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)	
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)	



LED Activity	LED Amber – Radio OFF LED Off – Radio ON
HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.	D/5.1/5.2 Wireless Technology
Bluetooth Specification	4.0/4.1/4.2/5.0/5.1/5.2 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.

1. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs. Wi-Fi 6[™] is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

3. Check latest software/driver release for updates on supported security features.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



Intel® XMM™ 7560 R+ LTE- Technole Advanced Pro ¹ bands		FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1900 (Band 25), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30), 1700/2100 (Band 66), 600 (band 71). TDD LTE: 2100 (Band 34), 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41), 3500 (Band 42), 3700 (Band 43), 3700 (band 48), 5200 (Band 46 RX only) MHz; HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8) MHz
Wireless standard	protocol İs	3GPP Release 12 LTE Specification DL-CAT.16, DL 100MHz BW throughput up to 978Mbps; UL-CAT.13 40MHz throughput up to 150Mbps WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
GPS		Standalone GPS/Beidou/Glonass, A-GPS (MS-A, MS-B)
GPS ban	ds	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz
Maximur	m data rates	LTE: 978 Mbps (Download), 150 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)
Maximur	m output power	LTE: 23 dBm in all band except B41 LTE B41 HPUE = 26dBm HSPA+: 23.5 dBm
Maximur consump		LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)
Form Fa	ctor	М.2, 3042-S3 Кеу В
Weight		6 g
Dimensie (Length : Thicknes	x Width x	42 x 30 x 2.3 mm
Embedd	ed eSIM	Support

1. Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.



Technical Specifications

rechnical Specifi	cations	
NXP NPC300 Near Field Communication Module	Dimensions (L x W x H) Chipset System interface NFC RF standards	Module 17 mm by 10 mm by 2.0 mm NPC300 I2C ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092 ECMA-340 NFCIP-1 Target and Initiator ECMA-320 NFCIP-2
	NFC Forum Support Reader (PCD-VCD) Mode(1)	Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2 ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K MIFARE 4K MIFARE DESFire FeliCa
	Card Emulation (PICC- VICC) Mode(1)	Jewel and Topaz cards ISO/IEC 14443 A ISO/IEC 14443 B and B' MIFARE FeliCa
	Frequency	13.56 MHz
	NFC Modes Supported	Reader/Writer, Peer-to-Peer
	Raw RF Data Rates	106, 212, 424, 848 kbps
	Operating temperature	0°C to 70°C
	Storage temperature	-20°C to 125°C
	Humidity	10-90% operating
		5-95% non-operating
	Supply Operating	2.97 to 5.5 Volts
	voltage I/O Voltage Power Consumption	1.8V or 3.3V
	(Booster enable, VBAT= 3	3.3V, VCC_BOOST = 5V)
	Mode	Power Consumption, Typical
	Polling	7.3 mA
	Detected Test Tag Type 1	32.9 mA
	Detected Test Tag Type 2	70.7 mA
	Detected Test Tag Type 3	79.2 mA
		tory configuration and requires separately purchased service contra- ility in your area. Connection speeds will yary due to location, envir

1. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. LTE not available on all products, in all regions



Realtek RTL8111HSH 10/100/1000 Integrated NIC	Ethernet Features	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s
	Power Management	Mbit/s ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power
		consumption
	Performance Features	TCP/IP/UDP Checksum Offload (configurable)
		Protocol Offload (ARP & NS)
		Large send offload and Giant send offload
		Receiving Side Scaling
	Managanahilitu	Jumbo Frame 9K
	Manageability	Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only)
		PXE 2.1 Remote Boot
		Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x,
		clause 30))
		Comprehensive diagnostic and configuration software suite
		Virtual Cable Doctor for Ethernet cable status
	Interface	PCIe + SMBus
	NIC Device Driver Name	Realtek PCIe GBE Ethernet Family Controller
Realtek RTL8111FPH	Ethernet Features	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)
10/100/1000	Ethernet Features	100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-
	Ethernet Features	100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30)
10/100/1000	Ethernet Features	100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-
10/100/1000	Ethernet Features	100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40)
10/100/1000		100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s
10/100/1000	Ethernet Features Power Management	100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s ACPI compliant – multiple power modes
10/100/1000		100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption
10/100/1000		100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power
10/100/1000	Power Management	100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption
10/100/1000		100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption TCP/IP/UDP Checksum Offload (configurable)
10/100/1000	Power Management	100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS)
10/100/1000	Power Management	100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload
10/100/1000	Power Management	100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS)
10/100/1000	Power Management	100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling
10/100/1000	Power Management Performance Features	100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling Jumbo Frame 9K Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only)
10/100/1000	Power Management Performance Features	100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling Jumbo Frame 9K Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot
10/100/1000	Power Management Performance Features	100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling Jumbo Frame 9K Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x,
10/100/1000	Power Management Performance Features	100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling Jumbo Frame 9K Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30))
10/100/1000	Power Management Performance Features	 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling Jumbo Frame 9K Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite
10/100/1000	Power Management Performance Features Manageability	 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling Jumbo Frame 9K Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status
10/100/1000	Power Management Performance Features	 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling Jumbo Frame 9K Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite

POWER



Technical Specifications

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

AC Adapter 45 Watt	Dimensions (H x W x D)	94.0mm x 40.0mm x 26.5n	nm
nPFC Standard USB type	Weight	192.5g +/-10%	
C Straight 1.8m	Input	Input Efficiency	Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec: 5V: 81.5% 9V: 86.7% 12V: 87.41% 15V: 87.8%
		Input frequency range	47 ~ 63Hz
		Input AC current	Max. 1.4 A at 90 Vac
	Output	Output power	5V/15W 9V/27W 12V/36W 15V/45W
		DC output	5V/9V/12V/15V
		Hold-up time	5ms at 115 Vac input
		Output current limit	<5.0A
	Connector	USB Type-C	
	Environmental Design	Operating temperature	32°F to 95°F (0° to 35°C)
		Non-operating (storage) temperature	-4°F to 185°F (-20° to 85°C)
		Altitude	0 to 16,400 ft (0 to 5,000m)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety Certifications	* Worldwide safety standa EN60950-1 and/or EN6236 SELV; Agency approvals - C-UL-U Class B, CISPR32 Class B, C	with LVD and EMC directives rds - IEC60950-1 and/or IEC62368-1, 58-1, UL60950-1 and/or UL62368-1, Class1, IS, NORDICS, DENAN, EN55032 Class B, FCC CC, NOM-001 NYCE. rs at 25°C ambient condition.
AC Adapter 45 Watt Smart nPFC Standard Barrel 4.5mm Right Angle 1.8m	Dimensions Weight Input	95 x 45 x 26.5mm unit: 200g +/- 10g Input Efficiency Input frequency range Input AC current	87.74 % at 115 Vac and 88.4 % at 230Vac 47 ~ 63 Hz Max. 1.4 A at 90 Vac
	Output	Output power	45W
		DC output	19.5V
		Hold-up time	5ms at 115 Vac input
	Connector	Output current limit 4.5mm Barrel Type	<8.0A



echnical Specif	ications		
	Environmental Design	Operating temperatu	re 32°F to 95°F (0°to 35°C)
		Non-operating (stora temperature	ge) -4°F to 185°F (-20°to 85°C)
		Altitude Humidity	0 to 16,400 ft (0 to 5,000m) 20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety Certifications	* Worldwide safety st EN60950-1 and/or EN SELV; Agency approvals - C- Class B, CISPR32 Class	ance with LVD and EMC directives andards - IEC60950-1 and/or IEC62368-1, N62368-1, UL60950-1 and/or UL62368-1, Class1 -UL-US, NORDICS, DENAN, EN55032 Class B, FCC s B, CCC, NOM-001 NYCE. D hours at 25°C ambient condition.
AC Adapter 65 Watt	Dimensions	90.0 x 51 x 28.5 mm	
nPFC Standard USB	Weight	unit: 250g +/- 10g	
Type-C [®] Straight 1.8m	Input	Input Efficiency	Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec: 5V: 81.5% 9V: 86.7% 12V: 88% 15V: 88% 20V: 89%
		Input frequency range	47 ~ 63 Hz
		Input AC current	1.6 A at 90 VAC and maximum load 5V/15W 9V/27W 12V/60W 15V/60W
	Output	Output power DC output	20V/65W 5V/9V/12V/15V/20V
		Hold-up time Output current limit	5ms at 115 Vac input <8.0A
	Connector Environmental Design	USB Type C Operating temperature	32°Fto 95°F (0°to 35°C)
		Non-operating (storage) temperature	-4°Fto 185°F (-20°to 85°C)
		(storage)	-4°Fto 185°F (-20°to 85°C) 0 to 16,400 ft (0 to 5,000m) 20% to 95

Technical Specif	ications		
	EMI and Safety Certifications	* Worldwide safety sta EN60950-1 and/or EN SELV; Agency approvals - C- Class B, CISPR32 Class	ance with LVD and EMC directives andards - IEC60950-1 and/or IEC62368-1, I62368-1, UL60950-1 and/or UL62368-1, Class1, -UL-US, NORDICS, DENAN, EN55032 Class B, FCC 5 B, CCC, NOM-001 NYCE. D hours at 25°C ambient condition.
AC Adapter 65 Watt	Dimensions	102 x 55 x 30mm	
Smart nPFC EM Barrel	Weight	unit: 250g +/- 10g	
4.5mm	Input	Input Efficiency Input frequency range	88.0 % at 115 Vac and 89.0 % at 230Vac 47 ~ 63 Hz
		Input AC current	Max. 1.7 A at 90 Vac
	Output	Output power	65W
		DC output	19.5V
		Hold-up time	5ms at 115 Vac input
		Output current limit	<11.0A
	Connector	4.5mm Barrel Type	
	Environmental Design	Operating temperature	32°F to 95°F (0°to 35°C)
		Non-operating (storage) temperature	-4°F to 185°F (-20°to 85°C)
		Altitude	0 to 16,400 ft (0 to 5,000m)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety Certifications	* Worldwide safety st EN60950-1 and/or EN SELV; Agency approvals - C- Class B, CISPR32 Class	ance with LVD and EMC directives andards - IEC60950-1 and/or IEC62368-1, I62368-1, UL60950-1 and/or UL62368-1, Class1, UL-US, NORDICS, DENAN, EN55032 Class B, FCC 5 B, CCC, NOM-001 NYCE. D hours at 25°C ambient condition.



Technical Specifications				
AC Adapter 65 Watt	Dimensions	90 x 51 x 28.5mm		
Smart nPFC Standard	Weight	230g +/-10%		
Barrel 4.5mm Right Angle 1.8m	Input	Input Efficiency	88.0 % at 115 Vac and 89.0 % at 230 Vac	
Angle 1.0m		Input frequency	47 ~ 63 Hz	
		range	Max. 1.7 A at 90 Vac	
	Outou	Input AC current	65W	
	Outpu	Output power DC output	19.5V	
		Hold-up time	5 ms at 115 Vac input	
		Output current limit	- <11.0A	
	Connector	4.5mm Barrel Type		
	Environmental Design	Operating temperature	32ºF to 95ºF (0ºto 35ºC)	
		Non-operating (storage) temperature	-4°F to 185°F (-20°to 85°C)	
		Altitude	0 to 16,400 ft (0 to 5000m)	
		Humidity	20% to 95%	
		Storage Humidity	10% to 95%	
	EMI and Safety Certifications	* Worldwide safety sta EN60950-1 and/or EN SELV; Agency approvals - C- Class B, CISPR32 Class	ance with LVD and EMC directives andards - IEC60950-1 and/or IEC62368-1, 62368-1, UL60950-1 and/or UL62368-1 , Class1, UL-US, NORDICS, DENAN, EN55032 Class B, FCC 5 B, CCC, NOM-001 NYCE.) hours at 25°C ambient condition.	
RH 42Wh ¹ Long Life Polymer Fast Charge 3	Dimensions (H x W x L) Weight	6.2 x 76.25 x 249.50 mr 0.18 kg (0.397 lb)	n (0.244 x 3.002 x 9.823 inch)	
cell Battery	Cells/Type	3cell Lithium-Ion Polym	er cell / 545974	
	Energy			
	Voltage	11.4V		
	Amp-hour capacity	3.752Ah		
	Watt-hour capacity ¹	42.75Wh		
	Temperature			
	Operating (Charging)	32° to 113° F (0° to 45°		
	Operating (Discharging)	14° to 122° F (-10° to 6	0°C)	
	Fuel Gauge LED	N/A		
	Warranty			
	Optional Travel Battery Available	No		



RH 51Wh ¹ Long Life Polymer Fast Charge 3 cell Battery	Dimensions (H x W x L) Weight Cells/Type	6.50 x 67.80 x 254.00 mm (0.256 x 2.669 x 10 inch) 0.2025 kg (0.446 lb) 3cell Lithium-Ion Polymer cell / 566075
	Energy	
	Voltage	11.58V
	Amp-hour capacity	4.431Ah
	Watt-hour capacity ¹	51.3Wh
	Temperature	
	Operating (Charging)	32° to 113° F (0° to 45° C)
	Operating (Discharging)	14° to 122° F (-10° to 60° C)
	Fuel Gauge LED Warranty	N/A
	Optional Travel Battery Available	Νο



Technical Specifications

AUDIO

HD Stereo Codec	ALC3247-CG
Audio I/O Ports	Headset: CTIA only and Headphone-out
Internal Speaker Amplifier	ALC 3247 has Embedded Class-D 2W Stereo Amplifier
Multi-streaming Capable	Playback multi-streaming can be enabled in the audio control panel to allow independent audio.
	Following MSFT Behavior
Sampling	DAC: 48kHz
	ADC: 44.1k/48kHz
Wavetable Syntheses	N/A
Analog Audio	Support 3.5mm Headset: CTIA only and Headphone-out
# of Channels on Line-Out	N/A
Internal Speaker	Yes

FINGERPRINT READER

Sensor vendor	Model: Elan efsa80ST (module P1515E)
Sensor type	Capacitive
DPI resolution	508 dpi
Scan area	80*80 pixels
False Rejection Rate	FRR: ≤ 3%
False Acceptance Rate	FAR: 1:100K
Mobile Voltage Operation	2.7V to 3.6V
Operating Temperature	-4°F – 175°F (-20° ~ +80°C)
Current Consumption Image	50mA peak
Low Latency Wait For Finger	900uA
Capture Rate	30 frame/sec
ESD Resistance	+15KV
Detection Matrix	80*80 pixels/ 508 dpi / 4*4mm sensor area



ENVIRONMENTAL DATA

Eco-Label Certifications &	This product has received	d or is in the process of bein	g certified to the following approvals and may	
declarations	be labeled with one or more of these marks:			
	IT ECO declaration			
	 US ENERGY STA 	R®		
	US Federal Ener	gy Management Program (F	EMP)	
			. See http://www.epeat.net for registration	
	status in your co			
	TCO Certified	Suntry.		
		nservation Program (CECP)		
		ironmental Protection Admi		
	Taiwan Green M			
	Korea Eco-label			
	Japan PC Green			
Sustainable Impact	 Ocean-bound plastic in 	•		
Specifications	 15% post-consumer re 	cycled plastic		
	 Low halogen 			
	-		stainably sourced and recyclable	
			tainably sourced and recyclable	
	 Bulk packaging availab 			
System Configuration	-		n and Declared Noise Emissions data for the	
	Notebook model is based	d on a "Typically Configured	Notebook".	
Energy Consumption				
(in accordance with US				
ENERGY STAR® test				
method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz	
Normal Operation (Sort	4.44 W	4.58 W	4.39 W	
idle)				
Normal Operation (Long	1.49 W	1.12 W	1.47 W	
idle)				
Sleep	1.49 W	1.12 W	1.47 W	
Off	0.31 W	0.35 W	0.30 W	
	Note:			
	Energy efficiency data lis	sted is for an ENERGY STAR®	compliant product if offered within the model	
	family. HP computers marked with the ENERGY STAR [®] Logo are compliant with the applicable U.S.			
	Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model			
	family does not offer ENERGY STAR [®] compliant configurations, then energy efficiency data listed is			
	for a typically configure	d PC featuring a hard disk	drive, a high efficiency power supply, and a	
	Microsoft Windows® ope	rating system.		
Heat Dissipation*			100VAC, 50Hz	
	115VAC, 60Hz	230VAC, 50Hz	1004AC, 50112	
Normal Operation (Short	115VAC, 60Hz	230VAL, 50HZ		
		-		
Normal Operation (Short idle)	115VAC, 60Hz 15.2 BTU/hr	15.7 BTU/hr	15 BTU/hr	
Normal Operation (Short idle) Normal Operation (Long	15.2 BTU/hr	15.7 BTU/hr	15 BTU/hr	
Normal Operation (Short idle) Normal Operation (Long idle)	15.2 BTU/hr 5.1 BTU/hr	15.7 BTU/hr 3.8 BTU/hr	15 BTU/hr 5 BTU/hr	
Normal Operation (Short idle) Uperation (Long idle) Sleep	15.2 BTU/hr 5.1 BTU/hr 5.1 BTU/hr	15.7 BTU/hr 3.8 BTU/hr 3.8 BTU/hr	15 BTU/hr 5 BTU/hr 5 BTU/hr	
Normal Operation (Short idle) Normal Operation (Long idle)	15.2 BTU/hr 5.1 BTU/hr 5.1 BTU/hr 1.1 BTU/hr	15.7 BTU/hr 3.8 BTU/hr 3.8 BTU/hr 1.2 BTU/hr	15 BTU/hr 5 BTU/hr 5 BTU/hr 1 BTU/hr	
Normal Operation (Short idle) Uperation (Long idle) Sleep	15.2 BTU/hr 5.1 BTU/hr 5.1 BTU/hr 1.1 BTU/hr	15.7 BTU/hr 3.8 BTU/hr 3.8 BTU/hr 1.2 BTU/hr	15 BTU/hr 5 BTU/hr 5 BTU/hr	



Additional Information fear Additional Information Information Packaging Materials Ext Interview Interview Th Th	s product ca tures and/or iod and or fo • This pr directi • This HI (WEEE • This pr Drinkir • This pr	r components contain or up to "5" years after roduct is in compliance ve - 2011/65/EC. P product is designed) Directive – 2002/96 roduct is in compliance	19 28 28 28 29 29 29 29 29 20 20 20 20 20 20 20 20 20 20 20 20 20	ecibels) 4.4 9.5 9.9 Veral years. Upgradeable e throughout the warranty ous Substances (RoHS)
Typically Configured – Idle Image: Sequential reads Optical Drive – Sequential reads This feat per Longevity and Upgrading This feat per Additional Information Image: Sequential per Packaging Materials Ext Image: Sequential per Image: Sequential per The sequence per sequence pe	tures and/or iod and or fo This pr directi This HI (WEEE This pr Drinkir This pr	2.4 3.3 n be upgraded, possil r components contain or up to "5" years after roduct is in complianc ve - 2011/65/EC. P product is designed) Directive – 2002/96 roduct is in complianc	19 28 28 28 29 29 29 29 29 20 20 20 20 20 20 20 20 20 20 20 20 20	9.5 8.9 Veral years. Upgradeable e throughout the warranty ous Substances (RoHS)
Fixed Disk – Random writes Image: Comparison of the sequential reads Longevity and Upgrading This feat per Additional Information Image: Comparison of the sequence of the seq	tures and/or iod and or fo This pr directi This HI (WEEE This pr Drinkir This pr	2.4 3.3 n be upgraded, possil r components contain or up to "5" years after roduct is in complianc ve - 2011/65/EC. P product is designed) Directive – 2002/96 roduct is in complianc	19 28 28 28 29 29 29 29 29 20 20 20 20 20 20 20 20 20 20 20 20 20	9.5 8.9 Veral years. Upgradeable e throughout the warranty ous Substances (RoHS)
Optical Drive - Sequential reads This feat per Longevity and Upgrading This feat per Additional Information Integrading Packaging Materials Ext Integrading This feat per This feat per Integrading This feat per This feat per Additional Information Integrading Packaging Materials Ext This feat per This feat per This feat per This feat per This feat per This feat per	tures and/or iod and or fo This pr directi This HI (WEEE This pr Drinkir This pr	3.3 n be upgraded, possil r components contain or up to "5" years afte roduct is in complianc ve - 2011/65/EC. P product is designed) Directive – 2002/96 roduct is in complianc	28 bly extending its useful life by sev ned in the spare parts are availabl er the end of production. The with the Restrictions of Hazardo to comply with the Waste Electric /EC.	8.9 veral years. Upgradeable e throughout the warranty ous Substances (RoHS)
reads This Longevity and Upgrading This fea per Additional Information Image: State	tures and/or iod and or fo This pr directi This HI (WEEE This pr Drinkir This pr	n be upgraded, possil r components contain or up to "5" years afte roduct is in complianc ve - 2011/65/EC. P product is designed) Directive – 2002/96 roduct is in complianc	bly extending its useful life by seven and in the spare parts are available er the end of production. The with the Restrictions of Hazardo to comply with the Waste Electric /EC.	veral years. Upgradeable e throughout the warranty ous Substances (RoHS)
Longevity and Upgrading This feat per Additional Information Image: Second	tures and/or iod and or fo This pr directi This HI (WEEE This pr Drinkir This pr	r components contain or up to "5" years after roduct is in compliance ve - 2011/65/EC. P product is designed) Directive – 2002/96 roduct is in compliance	ned in the spare parts are availabler the end of production. The with the Restrictions of Hazard to comply with the Waste Electric /EC.	e throughout the warranty ous Substances (RoHS)
fea per Additional Information Packaging Materials Ext Integration Integration Th Th	tures and/or iod and or fo This pr directi This HI (WEEE This pr Drinkir This pr	r components contain or up to "5" years after roduct is in compliance ve - 2011/65/EC. P product is designed) Directive – 2002/96 roduct is in compliance	ned in the spare parts are availabler the end of production. The with the Restrictions of Hazard to comply with the Waste Electric /EC.	e throughout the warranty ous Substances (RoHS)
Additional Information Additional Information Packaging Materials Ext Information Informatio Information Information Informati	 This pr direction This Hill (WEEE This pr Drinkir This pr 	or up to "5" years after roduct is in compliance ve - 2011/65/EC. P product is designed) Directive – 2002/96 roduct is in compliance	er the end of production. The with the Restrictions of Hazard to comply with the Waste Electric /EC.	ous Substances (RoHS)
Additional Information Additional Information Packaging Materials Ext End	 This pr directi This HI (WEEE) This pr Drinkir This pr 	oduct is in complianc ve - 2011/65/EC. P product is designed) Directive – 2002/96 roduct is in complianc	e with the Restrictions of Hazard to comply with the Waste Electric /EC.	
Packaging Materials Ext Image: Second system Image: Second system Image: Second system	directi This HI (WEEE This pr Drinkir This pr	ve – 2011/65/EC. P product is designed) Directive – 2002/96 roduct is in complianc	to comply with the Waste Electric /EC.	
Inte Th Th	 directive - 2011/65/EC. This HP product is designed to comply with the Waste Electrical and Electronic Equip (WEEE) Directive – 2002/96/EC. This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986). 		ndard at the Gold level, see e marked per ISO11469 and	
Inte Th Th	ernal: P	APER/Corrugated		245 g
Th Th		APER/Paperboard		50 g
Th Th		-		
Th Th		APER/Molded Pulp		192 g
Th		LASTIC/Polyethylene		10 g
			ains at least 0.0% recycled conte	
KOHS COMDUANCE I HP			aterials contains at least 61% rec regulations. We were among the	
the to c legi We elin incl and We req sco evo	the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam. We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances— including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products. We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve. To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.			
to	This product does not contain any of the following substances in excess of regulatory limits (re		the Environment at	



	 Certain Azo Colorants Certain Brominated Flame Retardants – may not be used as flame retardants in plastics Cadmium Chlorinated Hydrocarbons Chlorinated Paraffins Bis(2-Ethylhexyl) phthalate (DEHP) Benzyl butyl phthalate (BBP) Dibutyl phthalate (DBP) Disobutyl phthalate (DBP) Disobutyl phthalate (DIBP) Formaldehyde Halogenated Diphenyl Methanes Lead carbonates and sulfates Lead and Lead compounds Mercuric Oxide Batteries Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. Ozone Depleting Substances Polybrominated Biphenyl (PBBs) Polybrominated Biphenyl Oxides (PBBCs) Polybrominated Biphenyl (PCB) Polychlorinated Biphenyl (PCT) Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications. Radioactive Substances Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
Packaging Usage	 HP follows these guidelines to decrease the environmental impact of product packaging: Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. Eliminate the use of ozone-depleting substances (ODS) in packaging materials. Design packaging materials for ease of disassembly. Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management and Recycling	HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.



Technical Specifications

Inc.	Corporate	For more information about HP's commitment to the environment:			
Environmental Information					
		Global Citizenship Report			
		http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html			
		Eco-label certifications			
		http://www8.hp.com/us/en/hp-information/environment/ecolabels.html			
		ISO 14001 certificates:			
		http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842			
		and			
		http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf			
tes		Percentage of ocean-bound plastic contained in each component varies by product			
		Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-			
		2018 standard.			
		• External power supplies, WWAN modules, power cords, cables and peripherals excluded.			
		• 100% outer box packaging and corrugated cushions made from sustainably sourced			
		certified and recycled fibers.			
		• Fiber cushions made from 100% recycled wood fiber and organic materials.			
	mental I	mental Information			

COUNTRY OF ORIGIN

China



Options and Accessories (sold separately and availability may vary by country)

DOCKING (Sold Separately) Docking station model #1	HP Thunderbolt Dock G2
	plays 4
(incl.the notebook display)	
Max.resolutions supported	Dual 4K @30Hz or dual 4K UHD @ 60Hz is supported Dual 8K@ 60Hz for TB hosts or USB-C hosts DP 1.4 with DSC in high res mode
Dock Connectors	2xDP, 1xVGA, 1xTB, 1xUSB-C alt-mode
Technical limitations	Thunderbolt Hosts:
	Maximum of (4) displays with maximum resolution of 5K@ 30Hz running Thunderbolt host.
	Maximum resolution possible is dual 8K displays @ 60Hz running Thunderbolt host or running a non-Thunderbolt host in high resolution mode @30Hz Non-Thunderbolt hosts:
	The highest resolution for dual displays running a non-Thunderbolt host in multi-function mode is
	(1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port Non-Thunderbolt hosts support (3) displays with a maximum resolution of (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD @ 30Hz.
Docking station model #2	HP USB-C Dock G5
Total number of supported dia (incl.the notebook display)	plays 3
Max.resolutions supported	Dual 5K@ 30Hz + (1) 4K UHD (multi-function mode)
Dock Connectors	1xHDMI, 2xDP
Technical limitations	Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode.
	Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one 4K UHD@ 30 Hz on HDMI in Multi-function mode
	The highest resolution for a non-Thunderbolt host in multi-function mode is a single 5K dual cable (using both DP ports) + (1) 4K on HDMI port.
Docking station model #3	HP USB-C/A Universal Dock G2
Total number of supported di (incl.the notebook display)	plays 3
Max.resolutions supported	Triple 4K UHD@ 60Hz 3840 x 2160
Dock Connectors	1xHDMI, 2xDP
Technical limitations	The best resolution for dual or triple displays is 4K UHD@ 60Hz.
	For use with the USB-A adapter that comes in the box the maximum number of displays supported is (2) 4k x 60 Hz on the Type-A Gen 1 connection from the host.



Options and Accessories (sold separately and availability may vary by country)

Category	Descript	ion Part Numb	er
Audio/Video	HP Wired USB-A Stereo Headset	428K6AA	
	HP Wired 3.5mm Stereo Headset	428K7AA	
Cases	HP Business Slim 17.3 Top Load	2UW02AA	
	HP Executive 15.6 Backpack	6KD07AA	
	HP Executive 15.6 Top Load	6KD06AA	
	HP Executive 17.3 Backpack	6KD05AA	
	HP Executive 17.3 Top Load	6KD08AA	
	HP Executive Leather 15.6 Top Load	6KD09AA	
	HP Prelude G2 15.6 Backpack	1E7D6AA	
	HP Prelude G2 15.6 Top Load	1E7D7AA	
	HP Prelude Pro Recycled 15.6 Backpack	1X644AA	
	HP Prelude Pro Recycled 15.6 Top Load	1X645AA	
	HP Renew Business 17.3 Laptop Backpack	3E2U5AA	
	HP Renew Business 17.3 Laptop Bag	3E2U6AA	
	HP Renew Business 15.6 Laptop Bag	3E5F8AA	
Docking	HP Thunderbolt 120W G2 Dock	2UK37AA	
	HP Thunderbolt 120W G2 Dock w/Audio	3YE87AA	
	HP Thunderbolt 120W G4 Dock	4J0A2AA	
	HP Thunderbolt 230W G2 Dock w/Combo Cab	le 3TR87AA	
	HP Thunderbolt 280W G4 Dock w/Combo Cab	le 4JOG4AA	
	HP USB-C/A 120W G2 Universal Dock	5TW13AA	
	HP USB-C 120W G5 Dock	26D32AA	
	HP USB-C Mini Dock	1PM64AA	
Hub	HP Universal USB-C Multiport Hub	50H55AA	
	HP USB-C Travel Dock G2	7PJ38AA	
	HP USB-C to USB-A Hub	Z6A00AA	
Adapter	HP HDMI to DVI Adapter	F5A28AA	
	HP HDMI to VGA Adapter	H4F02AA	
	HP USB-C to DisplayPort Adapter	N9K78AA	
	HP USB-C to HDMI 2.0 Adapter	1WC36AA	
	HP USB-C to USB 3.0 Adapter	N2Z63AA	
	HP USB-C to VGA Adapter	N9K76AA	
Keyborad/Combo	HP 975 USB+BT Dual-Mode Wireless Keyboar	d 3Z726AA	
	HP 455 Programmable Wireless Keyboard	4R177AA	
	HP 125 WD USB Keyboard	266C9AA	
	HP 320K WD USB Keyboard	9SR37AA	
	HP 655 Wireless Keyboard and Mouse Combo	4R009AA	
	HP 225 Wired Mouse and Keyboard Combo	286J4AA	
	HP 235 Wireless Mouse and Keyboard Combo	1Y4DOAA	



Options and Accessories (sold separately and availability may vary by country)

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	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP Wireless Rechargeable 950MK Mouse and Keyboard	3M165AA
Mouse	HP USB Premium Wireless Mouse	1JR31AA
	HP 435 Multi-Device Wireless Mouse	3B4Q5AA
	HP 125 USB-A Wired Mouse	265A9AA
	HP 128 USB Laser Wired Mouse	265D9AA
	HP 320M USB-A Wired Mouse	9VA80AA
	HP Creator USB-A+Bluetooth 935 Wireless Mouse Black	1DOK8AA
	HP USB-A+Bluetooth Multi-Device 635 Wireless Mouse Black	1DOK2AA
	HP USB-A+Bluetooth Travel Bluetooth Mouse	6SP30AA
Power	HP 65W USB-C Auto Chevy AC Power Adapter	5TQ76AA
	HP 45W 4.5 mm Smart AC Power Adapter	H6Y88AA
	HP 45W USB-C G2 Zeus AC Power Adapter	1HE07AA
	HP 45W USB-C LC Dali AC Power Adapter	1MZ01AA
	HP 65W 4.5 mm LC Smart non-EM India Ony AC Power Adapter	3FF84AA#ACJ
	HP 65W 4.5 mm Smart AC Power Adapter	H6Y89AA
	HP 65W 4.5 mm wDongle 7.4 mm Slim AC Power Adapter	H6Y82AA
	HP 65W USB-C Hades AC Power Adapter	1HE08AA
	HP 65W USB-C LC AC Power Adapter	1P3K6AA
Commodity	HP USB DVD-Writer EXT ODD	F2B56AA
-	HP Nano Keyed Cable Lock	1AJ39AA
	HP Nano Master Keyed Cable Lock	1AJ40AA
	HP SureKey Standard/Nano/Wedge Cable Lock	6UW42AA



Summary of Changes

Date of change	Version History		Description of change
January 25, 2022	V1 to V2	Add	TPM, Smart reader, IPv6 Compliance and FirstNet Certified in Security section and Battery Life
February 11, 2022	V2 to V3	Update	USB Type-C [®] and HDMI from Ports/Slots section
February 22, 2022	V3 to V4	Update	Battery life and WWAN Module
March 1, 2022	V4 to V5	Add	Wake on WLAN in Networking section

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